

RoHS

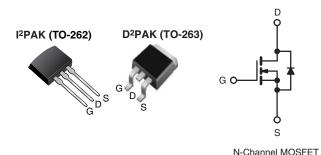
COMPLIANT

HALOGEN

FREE

Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	60				
R _{DS(on)} (Ω)	V _{GS} = 5 V 0.20				
Q _g (Max.) (nC)	8.4				
Q _{gs} (nC)	3.5				
Q _{gd} (nC)	6.0				
Configuration	Single				



FEATURES

• Halogen-free According to IEC 61249-2-21 **Definition**



- Surface Mount (IRLZ14S, SiHLZ14S)
- Low-Profile Through-Hole (IRLZ14L, SiHLZ14L)
- 175 °C Operating Temperature
- Fast Switching
- Compliant to RoHS Directive 2002/95/EC

DESCRIPTION

Third generation Power MOSFETs from Vishay utilize advanced processing techniques to achieve extermely low on-resistance per silicon area. This benefit, combined with the fast switching speed and ruggedized device design that Power MOSFETs are well known for, provides the designer with an extremely efficient reliable device for use in a wide variety of applications.

The D²PAK is a surface mount power package capable of accommodating die sizes up to HEX-4. It provides the highest power capability and lowest possible on-resistance in any existing surface mount package. The D2PAK is suitable for high current applications because of its low internal connection resistance and can dissipate up to 2.0 W in a typical surface mount application.

The through-hole version (IRLZ44L, SiHLZ44L) is available for low-profile applications.

ORDERING INFORMATION					
Package	D ² PAK (TO-263)	D ² PAK (TO-263)	D ² PAK (TO-263)	I ² PAK (TO-262)	
Lead (Pb)-free and Halogen-free	SiHLZ14S-GE3	SiHLZ14STRL-GE3a	SiHLZ14STRR-GE3a	-	
Lead (Pb)-free	IRLZ14SPbF	-	IRLZ14STRRPbFa	IRLZ14LPbF	
Lead (FB)-life	SiHLZ14S-E3	-	SiHLZ14STR-E3	SiHLZ14L-E3	

See device orientation.

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)						
PARAMETER		SYMBOL	LIMIT	UNIT		
Drain-Source Voltagee			V_{DS}	60	V	
Gate-Source Voltage			V_{GS}	± 10	7 °	
Continuous Drain Current	V _{GS} at 5 V	$T_{\rm C} = 25 ^{\circ}{\rm C}$ $T_{\rm C} = 100 ^{\circ}{\rm C}$	1	10		
Continuous Drain Current	V _{GS} at 5 V	T _C = 100 °C	I _D	7.2	Α	
Pulsed Drain Current ^{a, e}			I _{DM}	40	1	
Linear Derating Factor				0.29	W/°C	
Single Pulse Avalanche Energyb, e			E _{AS}	68	mJ	
Maximum Dower Dissipation	T _C =	25 °C	В	43	W	
Maximum Power Dissipation		25 °C P _D		3.7] vv	
Peak Diode Recovery dV/dtc, e			dV/dt	4.5	V/ns	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 175	- °C	
Soldering Recommendations (Peak Temperature)	for	10 s	-	300 ^d]	

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. $V_{DD}=25$ V, starting T_J = 25 °C, L = 790 μ H, R_g = 25 Ω , I_{AS} = 10 A (see fig. 12). c. I_{SD} ≤ 10 A, dI/dt ≤ 90 A/ μ s, V_{DD} ≤ V_{DS}, T_J ≤ 175 °C. d. 1.6 mm from case.

- Uses IRLZ14, SiHLZ14 data and test conditions.

^{*} Pb containing terminations are not RoHS compliant, exemptions may apply

IRLZ14S, IRLZ14L, SiHLZ14S, SiHLZ14L

Vishay Siliconix



THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	TYP.	MAX.	UNIT		
Maximum Junction-to-Ambient (PCB Mount) ^a	R _{thJA}	-	40	°C/W		
Maximum Junction-to-Case (Drain)	R_{thJC}	-	3.5			

Note

a. When mounted on 1" square PCB (FR-4 or G-10 material).

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0$, $I_D = 250 \mu A$		60	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 1 mA	-	0.07	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	· V _{GS} , I _D = 250 μA	1.0	-	2.0	V
Gate-Source Leakage	I _{GSS}	,	V _{GS} = ± 10 V	-	-	± 100	nA
Zoro Coto Voltago Droin Current	1	V _{DS} :	= 60 V, V _{GS} = 0 V	-	-	25	μA
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 48 \text{ V}$	V _{GS} = 0 V, T _J = 150 °C	-	-	250	μΑ
Drain-Source On-State Resistance	Б	V _{GS} = 5 V	I _D = 6.0 A ^b	-	-	0.2	
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 4 V	I _D = 5.0 A ^b	-	-	0.28	Ω
Forward Transconductance	9 _{fs}	V _{DS} :	= 25 V, I _D = 6.0 A	3.5	-	-	S
Dynamic							
Input Capacitance	C _{iss}		$V_{GS} = 0 \text{ V},$ $V_{DS} = 25 \text{ V},$ $f = 1.0 \text{ MHz, see fig. 5}$		400	-	pF
Output Capacitance	C _{oss}]			170	-	
Reverse Transfer Capacitance	C _{rss}	f = 1.			42	-	
Total Gate Charge	Qg			-	-	8.4	
Gate-Source Charge	Q _{gs}	V _{GS} = 5 V	$V_{GS} = 5 \text{ V}$ $I_D = 10 \text{ A}, V_{DS} = 48 \text{ V},$ see fig. 6 and 13 ^b		-	3.5	nC
Gate-Drain Charge	Q_{gd}		goo ng. o ana ro	-	-	6.0	1
Turn-On Delay Time	t _{d(on)}	V _{DD} = 30 V, I _D = 10 A,		-	9.3	-	
Rise Time	t _r			-	110	-	
Turn-Off Delay Time	t _{d(off)}	$R_g = 12 \Omega$,	$R_D = 2.8 \Omega$, see fig. 10^b	-	17	-	ns
Fall Time	t _f			-	26	-	
Internal Source Inductance	L _S	Between lead	, and center of die contact	-	7.5	-	nH
Drain-Source Body Diode Characteristic	es						
Continuous Source-Drain Diode Current	I _S	MOSFET sym showing the		-	-	10	A
Pulsed Diode Forward Current ^a	I _{SM}	integral reverse p - n junction diode		-	-	40	
Body Diode Voltage	V _{SD}	T _J = 25 °C	C, I _S = 10 A, V _{GS} = 0 V ^b	-	-	1.6	V
Body Diode Reverse Recovery Time	t _{rr}	T 05 00 1	10 A 41/4+ 100 A/h	-	93	130	ns
Body Diode Reverse Recovery Charge	Q _{rr}	$-$ T _J = 25 °C, I _F = 10 A, dl/dt = 100 A/ μ s ^b		-	340	650	nC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by L _S and L _D)			1 - \		

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width \leq 300 μ s; duty cycle \leq 2 %.

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

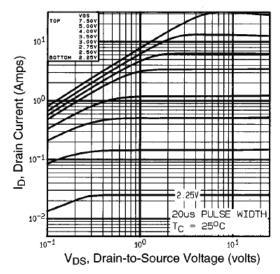


Fig. 1 - Typical Output Characteristics

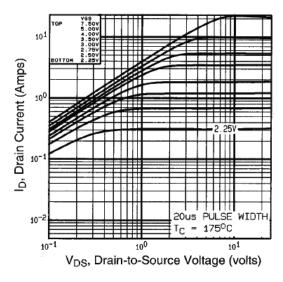


Fig. 2 - Typical Output Characteristics

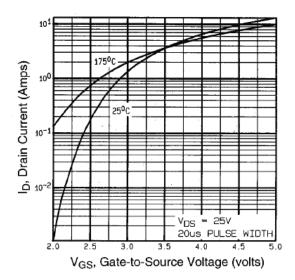


Fig. 3 - Typical Transfer Characteristics

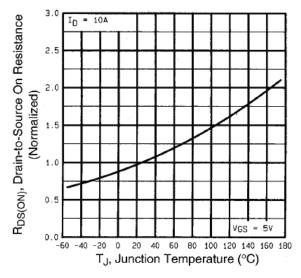


Fig. 4 - Normalized On-Resistance vs. Temperature



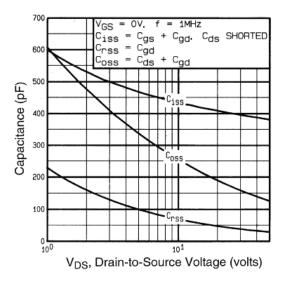


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

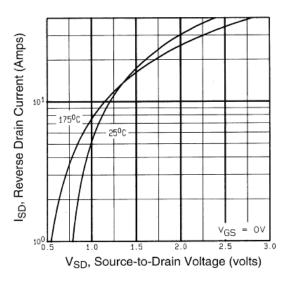


Fig. 7 - Typical Source-Drain Diode Forward Voltage

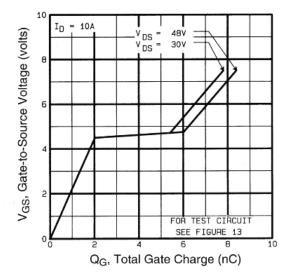


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

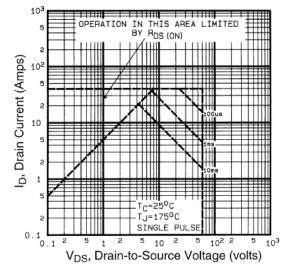


Fig. 8 - Maximum Safe Operating Area

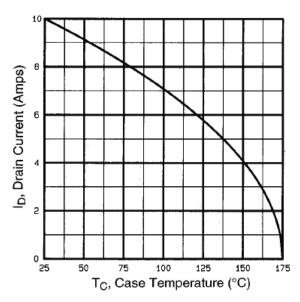


Fig. 9 - Maximum Drain Current vs. Case Temperature

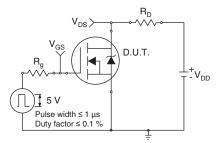


Fig. 10a - Switching Time Test Circuit

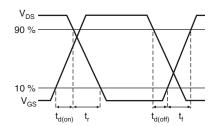


Fig. 10b - Switching Time Waveforms

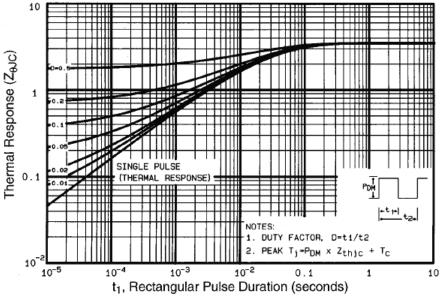
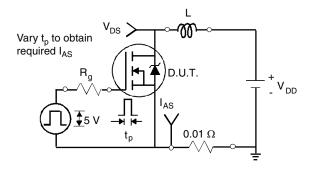


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case





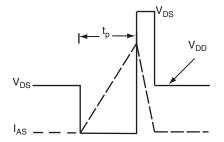


Fig. 12a - Unclamped Inductive Test Circuit

Fig. 12b - Unclamped Inductive Waveforms

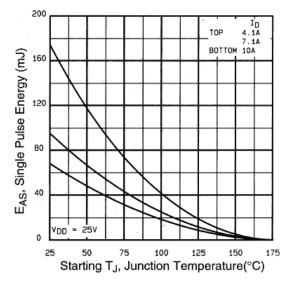


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

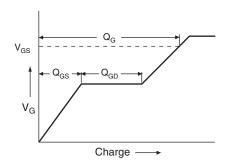


Fig. 13a - Basic Gate Charge Waveform

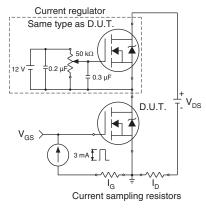
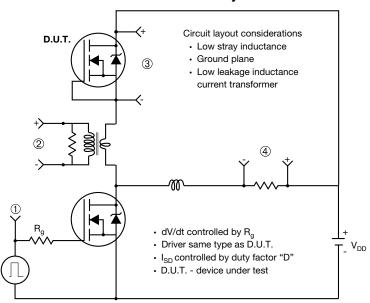


Fig. 13b - Gate Charge Test Circuit

Peak Diode Recovery dV/dt Test Circuit



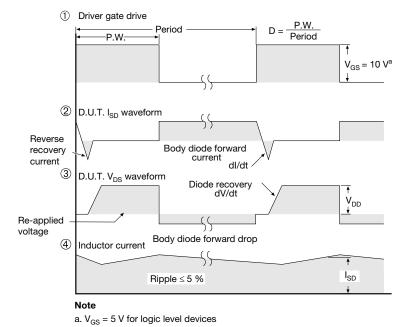


Fig. 14 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?90414.





TO-263AB (HIGH VOLTAGE)







	MILLIN	METERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
Α	4.06	4.83	0.160	0.190
A1	0.00	0.25	0.000	0.010
b	0.51	0.99	0.020	0.039
b1	0.51	0.89	0.020	0.035
b2	1.14	1.78	0.045	0.070
b3	1.14	1.73	0.045	0.068
С	0.38	0.74	0.015	0.029
c1	0.38	0.58	0.015	0.023
c2	1.14	1.65	0.045	0.065
D	8.38	9.65	0.330	0.380

	MILLIMETERS		INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
D1	6.86	-	0.270	-
Е	9.65	10.67	0.380	0.420
E1	6.22	-	0.245	ı
е	2.54 BSC		0.100 BSC	
Н	14.61	15.88	0.575	0.625
L	1.78	2.79	0.070	0.110
L1	-	1.65	ı	0.066
L2	-	1.78	-	0.070
L3	0.25 BSC		0.010	BSC
L4	4.78	5.28	0.188	0.208

ECN: S-82110-Rev. A, 15-Sep-08

DWG: 5970

Notes

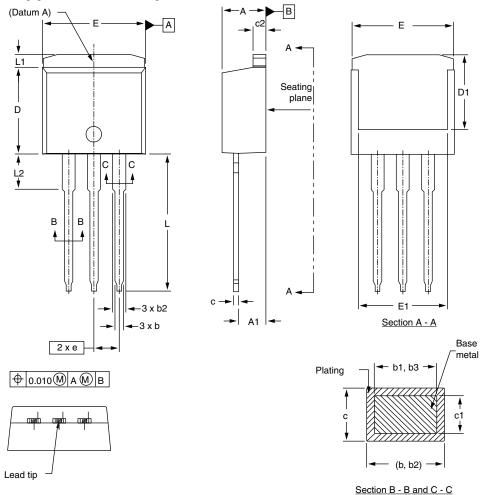
- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimensions are shown in millimeters (inches).
- 3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body at datum A.
- 4. Thermal PAD contour optional within dimension E, L1, D1 and E1.
- 5. Dimension b1 and c1 apply to base metal only.
- 6. Datum A and B to be determined at datum plane H.
- 7. Outline conforms to JEDEC outline to TO-263AB.

Document Number: 91364 www.vishay.com Revision: 15-Sep-08





I²PAK (TO-262) (HIGH VOLTAGE)



	MILLIMETERS		INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
Α	4.06	4.83	0.160	0.190
A1	2.03	3.02	0.080	0.119
b	0.51	0.99	0.020	0.039
b1	0.51	0.89	0.020	0.035
b2	1.14	1.78	0.045	0.070
b3	1.14	1.73	0.045	0.068
С	0.38	0.74	0.015	0.029
c1	0.38	0.58	0.015	0.023
c2	1.14	1.65	0.045	0.065

	MILLIMETERS		INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
D	8.38	9.65	0.330	0.380
D1	6.86	-	0.270	-
Е	9.65	10.67	0.380	0.420
E1	6.22	-	0.245	-
е	2.54	BSC	0.100 BSC	
L	13.46	14.10	0.530	0.555
L1	-	1.65	-	0.065
L2	3.56	3.71	0.140	0.146

Scale: None

ECN: S-82442-Rev. A, 27-Oct-08 DWG: 5977

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm per side. These dimensions are measured at the outmost extremes of the plastic body.
- 3. Thermal pad contour optional within dimension E, L1, D1, and E1.
- 4. Dimension b1 and c1 apply to base metal only.

Document Number: 91367 Revision: 27-Oct-08



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